

In re Application of:	
Naoshi ADACHI et al.	Art Unit: 2812
Serial No.: 10/750,883	Examiner: not yet assigned
Filed: January 5, 2004	Confirmation No.: 2099

For:

Heat Treatment Jig for Semiconductor Substrate and Method of Heat Treating

Semiconductor Substrate

SUBMISSION OF AMENDED DRAWINGS

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Enclosed is one sheet of replacement drawings to amend Figure 8 of the formal drawings filed January 5, 2004 with this application. The thickness is now correctly noted as **Ht**.

Entry is respectfully requested.

Respectfully submitted,

CLARK/& BRODY

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Docket No.: 12054-0023

Date: May 24, 2004